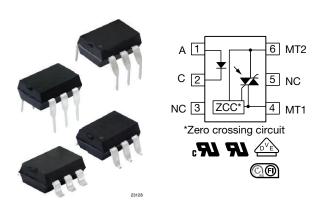


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Vishay Semiconductors

# bOptocoupler, Phototriac Output, Zero Crossing, Very Low Input Current



#### **LINKS TO ADDITIONAL RESOURCES**













#### **DESCRIPTION**

The IL4116, IL4117, and IL4118 product family consists of an optically coupled GaAs IRLED to a photosensitive thyristor system with integrated noise suppression and zero crossing circuit.

The thyristor system enables low trigger currents of 0.7 mA and features a dV/dt ratio of greater than 10 kV/ $\mu$ s and load voltages up to 800 V.

The IL4116, IL4117, and IL4118 product family is a perfect microcontroller friendly solution to isolate low voltage logic from high voltage 120  $V_{AC},\,240\,V_{AC},\,$  and 380  $V_{AC}$  lines and to control resistive, inductive, or capacitive AC loads like motors, solenoids, high power thyristors or TRIACs, and solid-state relays.

### **FEATURES**

- Low trigger current I<sub>FT</sub> = 0.7 mA (typ.)
- I<sub>TRMS</sub> = 300 mA
- High static dV/dt ≥ 10 000 V/µs
- Load voltage up to 800 V
- Zero voltage crossing detector
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>





#### RoHS COMPLIANT

#### **APPLICATIONS**

- Solid-state relay
- · Lighting controls
- Temperature controls
- · Solenoid / valve controls
- AC motor drives / starters

#### **AGENCY APPROVALS**

IL4117-X007

700

IL4118-X007T (1)

IL4118-X009T

800

IL4118-X017 (1)

- UL
- cUL
- DIN EN 60747-5-5 (VDE 0884-5), available with option 1
- FIMKO

ORDERING INFORMATION				
I L 4 1 1 PART NUMBER	# - X 0	# # T AGE OPTION TAPE AND REEL	Option 7 Option 7 Option 9  > 0.7 mm	
AGENCY CERTIFIED / PACKAGE	PEAK OFF-STATE VOLTAGE V <sub>DRM</sub> (V)			
UL, cUL, FIMKO	600 700		800	
DIP-6	IL4116 IL4117 IL4118			
DIP-6 400 mil option 6	_	_	II 4118-X006	

IL4116-X007T (1)

IL4116-X009T

600

#### Notes

SMD-6, option 7 SMD-6, option 9

SMD-6, option 7

VDE, UL, cUL, FIMKO

- Additional options may be possible, please contact sales office
- (1) Also available in tubes, do not put T on the end

Rev. 2.1, 12-Apr-2023 **1** Document Number: 83628



<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT		
INPUT							
Reverse voltage			$V_R$	6	V		
Forward current			I <sub>F</sub>	60	mA		
Surge current			I <sub>FSM</sub>	2.5	Α		
Power dissipation			P <sub>diss</sub>	100	mW		
Derate linearly from 25 °C				1.33	mW/°C		
Thermal resistance			R <sub>th</sub>	750	°C/W		
OUTPUT							
		IL4116	$V_{DRM}$	600	V		
Peak off-state voltage		IL4117	$V_{DRM}$	700	V		
		IL4118	$V_{DRM}$	800	V		
RMS on-state current			I <sub>DRM</sub>	300	mA		
Single cycle surge				3	Α		
Power dissipation			P <sub>diss</sub>	500	mW		
Derate linearly from 25 °C				6.6	mW/°C		
Thermal resistance			R <sub>th</sub>	150	°C/W		
COUPLER							
Storage temperature			T <sub>stg</sub>	-55 to +150	°C		
Operating temperature			T <sub>amb</sub>	-55 to +100	°C		
Lead soldering temperature	5 s		T <sub>sld</sub>	260	°C		

#### Note

<sup>•</sup> Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability



PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT							
Forward voltage	I <sub>F</sub> = 20 mA		$V_{F}$	-	1.3	1.5	V
Breakdown voltage	I <sub>R</sub> = 10 μA		$V_{BR}$	6	30	-	V
Reverse current	V <sub>R</sub> = 6 V		I <sub>R</sub>	-	0.1	10	μΑ
Capacitance	$V_F = 0 V$ , $f = 1 MHz$		Co	-	40	-	pF
Thermal resistance, junction to lead			R <sub>thjl</sub>	-	750	-	°C/W
OUTPUT							
		IL4116	$V_{DRM}$	600	650	-	V
Repetitive peak off-state voltage	$I_{DRM} = 100 \mu A$	IL4117	$V_{DRM}$	700	750	-	V
		IL4118	$V_{DRM}$	800	850	-	V
		IL4116	V <sub>D(RMS)</sub>	424	460	-	V
Off-state voltage	$I_{D(RMS)} = 70 \mu A$	IL4117	V <sub>D(RMS)</sub>	494	536	-	V
		IL4118	V <sub>D(RMS)</sub>	565	613	-	V
Off-state current	V <sub>D</sub> = 600, T <sub>amb</sub> = 100 °C		I <sub>D(RMS)</sub>	-	10	100	μΑ
On-state voltage	I <sub>T</sub> = 300 mA		$V_{TM}$	-	1.7	3	V
On-state current	PF = 1, V <sub>T(RMS)</sub> = 1.7 V		I <sub>TM</sub>	-	-	300	mA
Surge (non-repetitive, on-state current)	f = 50 Hz		I <sub>TSM</sub>	-	-	3	Α
Holding current	V <sub>T</sub> = 3 V		I <sub>H</sub>	-	65	200	μΑ
Latching current	V <sub>T</sub> = 2.2 V		ال	-	-	500	μΑ
LED trigger current	$V_{AK} = 5 V$		I <sub>FT</sub>	-	0.7	1.3	mA
Zero cross inhibit voltage	$I_F = \text{rated } I_{FT}$		V <sub>IH</sub>	-	15	25	V
	$V_{RM}$ , $V_{DM} = 400 V_{AC}$		dV/dt <sub>cr</sub>	10 000	-	-	V/µs
Critical rate of rise off-state voltage	$V_{RM}$ , $V_{DM} = 400 V_{AC}$ , $T_{amb} = 80 °C$		dV/dt <sub>cr</sub>	-	2000	-	V/µs
Critical rate of rise of voltage at current commutation	$V_D = 230 V_{RMS}$ , $I_D = 300 \text{ mA}_{RMS}$ , $T_J = 25 ^{\circ}\text{C}$		dV/dt <sub>crq</sub>	-	8	-	V/µs
	$V_D = 230 V_{RMS}$ , $I_D = 300 \text{ mA}_{RMS}$ , $T_J = 85 ^{\circ}\text{C}$		dV/dt <sub>crq</sub>	-	7	_	V/µs
Critical rate of rise of on-state current commutation	$V_D = 230 \text{ V}_{RMS},$ $I_D = 300 \text{ mA}_{RMS}, T_J = 25 \text{ °C}$		dV/dt <sub>crq</sub>	-	12	-	A/ms
Thermal resistance, junction to lead			R <sub>thjl</sub>	-	150	-	°C/W
COUPLER							
Critical state of rise of coupler input-output voltage	$I_T = 0 A, V_{RM} = V_{DM} = 424 V_{AC}$		dV <sub>(IO)</sub> /dt	10 000	-	-	V/µs
Capacitance (input to output)	f = 1 MHz, V <sub>IO</sub> = 0 V		C <sub>IO</sub>	-	0.8	-	pF
Common mode coupling capacitance			C <sub>CM</sub>	-	0.01	-	pF

### Note

 Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements

SWITCHING CHARACTERISTICS						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Turn-on time	$V_{RM} = V_{DM} = 424 V_{AC}$	t <sub>on</sub>	-	35	-	μs
Turn-off time	PF = 1, I <sub>T</sub> = 300 mA	t <sub>off</sub>	-	50	-	μs

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Climatic classification	According to IEC 68 part 1		55 / 100 / 21	
Comparative tracking index		CTI	175	
Maximum rated withstanding isolation voltage	t = 1 min	V <sub>ISO</sub>	4420	V <sub>RMS</sub>
Maximum transient isolation voltage		V <sub>IOTM</sub>	8000	V <sub>peak</sub>
Maximum repetitive peak isolation voltage		$V_{IORM}$	890	V <sub>peak</sub>
Isolation resistance	V <sub>IO</sub> = 500 V, T <sub>amb</sub> = 25 °C	R <sub>IO</sub>	≥ 10 <sup>12</sup>	Ω
	V <sub>IO</sub> = 500 V, T <sub>amb</sub> = 100 °C	R <sub>IO</sub>	≥ 10 <sup>11</sup>	Ω
Output safety power		$P_{SO}$	500	mW
Input safety current		I <sub>SI</sub>	250	mA
Safety temperature		T <sub>S</sub>	175	°C
Crannaga diatanaa	DIP-6; SMD-6, option 7; SMD-6, option 9		≥ 7	mm
Creepage distance	DIP-6, 400 mil, option 6		≥ 8	mm
Olas and all days	DIP-6; SMD-6, option 7; SMD-6, option 9		≥ 7	mm
Clearance distance	DIP-6, 400 mil, option 6		≥ 8	mm
Insulation thickness		DTI	≥ 0.4	mm

#### Note

## TYPICAL CHARACTERISTICS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

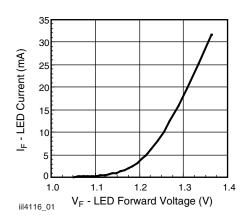


Fig. 1 - LED Forward Current vs. Forward Voltage

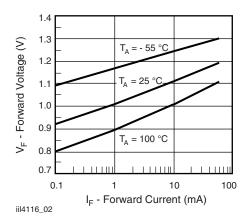


Fig. 2 - Forward Voltage vs. Forward Current

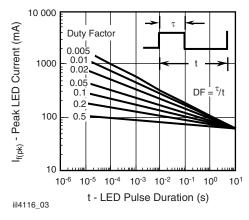


Fig. 3 - Peak LED Current vs. Duty Factor,  $\tau$ 

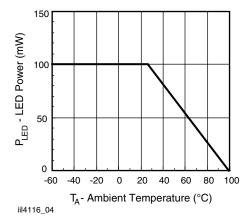


Fig. 4 - Maximum LED Power Dissipation

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As per IEC 60747-5-5, § 7.4.3.8.2, this optocoupler is suitable for "safe electrical insulation" only within the safety ratings. Compliance with
the safety ratings shall be ensured by means of protective circuits

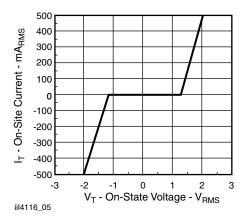


Fig. 5 - On-State Terminal Voltage vs. Terminal Current

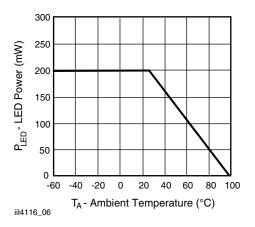


Fig. 6 - Maximum Output Power Dissipation

#### TRIGGER CURRENT VS. TEMPERATURE AND VOLTAGE

The trigger current of the IL4116, IL4117, IL4118 has a positive temperature gradient and also is dependent on the terminal voltage as shown as the fig. 7.

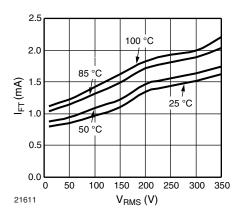


Fig. 7 - Trigger Current vs.
Temperature and Operating Voltage (50 Hz)

For the operating voltage 250  $V_{RMS}$  over the temperature range -40 °C to +85 °C, the  $I_F$  should be at least 2.3 x of the  $I_{FT1}$  (1.3 mA, max.).

Considering -30 % degradation over time, the trigger current minimum is  $I_F = 1.3 \times 2.3 \times 130 \% = 4 \text{ mA}$ 

### **INDUCTIVE AND RESISTIVE LOADS**

For inductive loads, there is phase shift between voltage and current, shown in the Fig. 8.

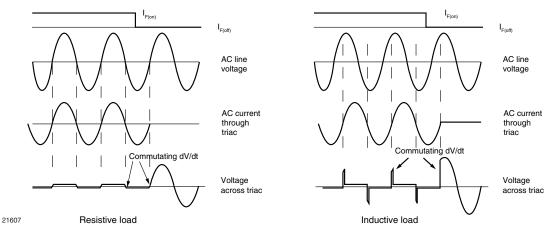


Fig. 8 - Waveforms of Resistive and Inductive Loads

The voltage across the triac will rise rapidly at the time the current through the power handling triac falls below the holding current and the triac ceases to conduct. The rise rate of voltage at the current commutation is called commutating dV/dt. There would be two potential problems for ZC phototriac control if the commutating dV/dt is too high. One is lost control to turn off, another is failed to keep the triac on.

#### **Lost Control to Turn Off**

If the commutating dV/dt is too high, more than its critical rate (dV/dt $_{\rm crq}$ ), the triac may resume conduction even if the LED drive current I $_{\rm F}$  is off and control is lost.

In order to achieve control with certain inductive loads of power factors is less than 0.8, the rate of rise in voltage (dV/dt) must be limited by a series RC network placed in parallel with the power handling triac. The RC network is called snubber circuit. Note that the value of the capacitor increases as a function of the load current as shown in fig. 9.

### Failed to Keep On

As a zero-crossing phototriac, the commutating dV/dt spikes can inhibit one half of the TRIAC from keeping on If the spike potential exceeds the inhibit voltage of the zero cross detection circuit, even if the LED drive current I<sub>F</sub> is on.

This hold-off condition can be eliminated by using a snubber and also by providing a higher level of LED drive current. The higher LED drive provides a larger photocurrent which causes the triac to turn-on before the commutating spike has activated the zero cross detection circuit. Fig. 10 shows the relationship of the LED current for power factors of less than 1.0. The curve shows that if a device requires 1.5 mA for a resistive load, then 1.8 times (2.7 mA) that amount would be required to control an inductive load whose power factor is less than 0.3 without the snubber to dump the spike.

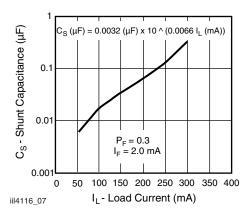


Fig. 9 - Shunt Capacitance vs. Load Current vs. Power Factor

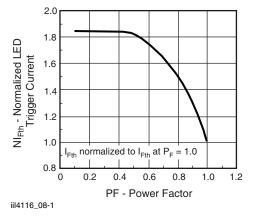


Fig. 10 - Normalized LED Trigger Current



### **APPLICATIONS**

#### Direct switching operation:

The IL4116, IL4117, IL4118 isolated switch is mainly suited to control synchronous motors, valves, relays and solenoids. Fig. 11 shows a basic driving circuit. For resistive load the snubber circuit  $R_S$   $C_S$  can be omitted due to the high static dV/dt characteristic.

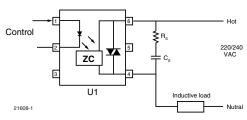


Fig. 11 - Basic Direct Load Driving Circuit

### Indirect switching operation:

The IL4116, IL4117, IL4118 switch acts here as an isolated driver and thus enables the driving of power thyristors and power triacs by microprocessors. Fig. 12 shows a basic driving circuit of inductive load. The resister R1 limits the driving current pulse which should not exceed the maximum permissible surge current of the IL4116, IL4117, IL4118. The resister  $R_G$  is needed only for very sensitive thyristors or triacs from being triggered by noise or the inhibit current.

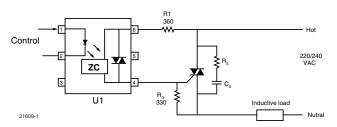
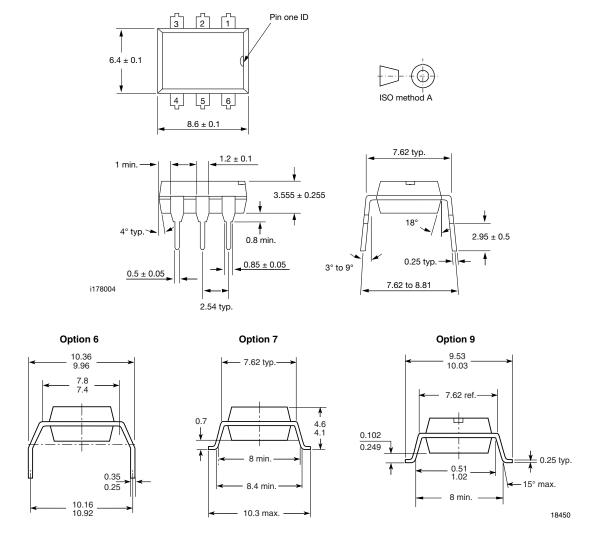


Fig. 12 - Basic Power Triac Driver Circuit

### **PACKAGE DIMENSIONS** (in millimeters)



### **PACKAGE MARKING** (example)



Fig. 13 - Example of IL4118-X017

#### Notes

- XXXX = LMC (lot marking code)
- · VDE logo is only marked on option 1 parts
- Tape and reel suffix (T) is not part of the package marking

### **PACKING INFORMATION**

DEVICES PER TUBE						
TYPE	UNITS/TUBE	TUBES/BOX	UNITS/BOX			
DIP-6	50	40	2000			

### TAPE AND REEL SPECIFICATIONS

Surface-mounted devices are packaged in embossed tape and wound onto 13" molded plastic reels for shipment, to comply with Electronics Industries Association Standard EIA-481, revision A, and International Electrotechnical Commission standard IEC 60286.

#### **Leaders and Trailers**

The carrier tape and cover tape are not spliced. Both tapes are one single uninterrupted piece from end to end, as shown in figure 2. Both ends of the tape have empty pockets meeting these requirements.

- Trailer end (inside hub of reel) is 200 mm minimum
- Leader end (outside of reel) is 400 mm minimum and 560 mm maximum
- Unfilled leader and trailer pockets are sealed
- Leaders and trailers are taped to tape and hub, respectively, with masking tape
- All materials are static-dissipative

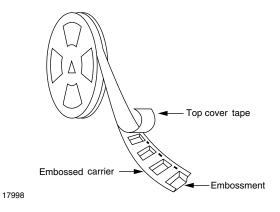


Fig. 14 - Tape and Reel Shipping Medium

### TAPE AND REEL PACKAGING FOR SMD-6 OPTOCOUPLERS WITH OPTION 7

Dimensions in millimeters

Selected 6 pin optocouplers with option 7 are available in tape and reel format. To order 6 pin optocoupler with option 7 on tape and reel, add a suffix "T" after the option, i.e., CNY17-3X007T.

The tape is 16 mm and is wound on a 33 cm reel. There are 1000 parts per reel. Taped and reeled 6 pin optocouplers conform to EIA-481-2 and IEC 60286-3.

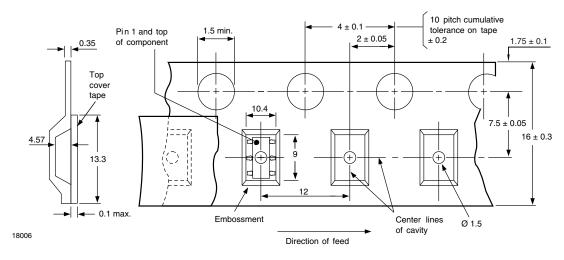


Fig. 15

### TAPE AND REEL PACKAGING FOR SMD-6 OPTOCOUPLERS WITH OPTION 9

Dimensions in millimeters

Selected 6 pin optocouplers with option 9 are available in tape and reel format. To order 6 pin optocoupler with option 9 on tape and reel, add a suffix "T" after the option, i.e., CNY17-3X009T.

The tape is 16 mm and is wound on a 33 cm reel. There are 1000 parts per reel. Taped and reeled 6 pin optocouplers conform to EIA-481-2 and IEC 60286-3.

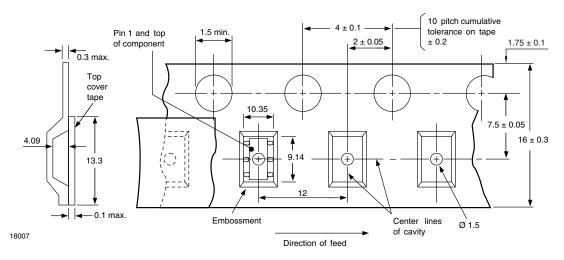


Fig. 16



### **REEL DIMENSIONS** in millimeters

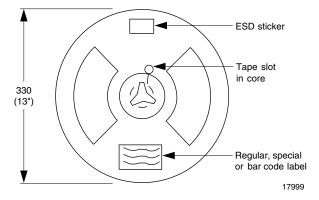


Fig. 16 - Reel Dimensions

### HANDLING AND STORAGE CONDITIONS

ESD level: HBM class 2 Floor life: unlimited

Conditions:  $T_{amb}$  < 30 °C, RH < 85 %

Moisture sensitivity level 1, according to J-STD-020

### **SOLDER PROFILES**

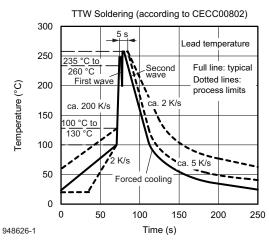


Fig. 17 - Wave Soldering Double Wave Profile According to J-STD-020 for DIP-8 Devices

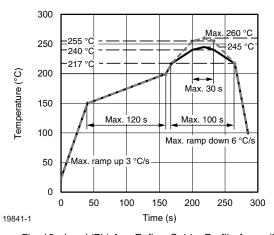


Fig. 18 - Lead (Pb)-free Reflow Solder Profile According to J-STD-020 for SMD-8 Devices

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